

Press Release

CONTACT: Christy Petty Gartner + 1 408 468 8312 christy.pettey@gartner.com

Laurence Goasduff Gartner + 44 (0) 1784 267 738 Laurence.goasduff@gartner.com

Gartner Says Worldwide Semiconductor Capital Equipment Spending to Grow 10.2 Per Cent in 2011

Market Forces, Not the Tragic Events in Japan, Will Govern 2011 Semiconductor Equipment Spending

STAMFORD, Conn. June 15, 2011 — Worldwide semiconductor capital equipment spending is on track to reach \$44.8 billion in 2011, a 10.2 per cent increase from 2010 spending of \$40.6 billion, according to Gartner, Inc. However, analysts warned that a looming semiconductor inventory correction, combined with oversupply in foundry, will lead to a slight spending decline in 2012.

"Capital spending and the equipment picture have changed little since our last forecast in the first quarter of 2011, in spite of the disastrous earthquake in Japan, which threatened to disrupt the electronics supply chain," said Klaus Rinnen, managing vice president at Gartner. "Thanks to Herculean efforts by Japanese vendors, the effects of the quake were minimised."

All segments of the semiconductor capital equipment market are expected to experience growth in 2011 (see Table 1). Gartner analysts said 2011 spending is being driven by aggressive foundry spending, integrated device manufacturer (IDM) logic capacity ramping up at the leading edge, and memory companies gearing up for double patterning. Semiconductor capital equipment spending in 2012 will see a 2.6 per cent decline, followed by 8.9 per cent growth in 2013. The next cyclical decline should begin in late 2013, as the impact of memory oversupply takes its toll.

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	2009	2010	2011	2012	2013	2014	2015
Semiconductor Capital Spending	25,876.3	56,154.3	62,838.0	61,178.1	66,605.3	56,532.8	64,257.8
Growth (%)	-41.2	117.0	11.9	-2.6	8.9	-15.1	13.7
Capital Equipment	16,742.5	40,639.1	44,765.1	42,052.3	46,477.4	38,925.5	45,675.9
Growth (%)	-45.4	142.7	10.2	-6.1	10.5	-16.2	17.3
Wafer Fab Equipment	12,884.2	31,624.7	35,332.6	34,180.0	37,097.5	31,188.7	35,780.6
Growth (%)	-46.8	145.5	11.7	-3.3	8.5	-15.9	14.7
Packaging and Assembly Equipment	2,708.5	6,154.6	6,373.9	5,386.5	6,333.3	5,422.7	6,827.2

Table 1

Worldwide Semiconductor Capita	I Equipment Spending	- Forecast 2009-201	5 (Millions of Dollars)
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Growth (%)	-32.3	127.2	3.6	-15.5	17.6	-14.4	25.9
Automated Test Equipment	1,149.8	2,859.8	3,058.6	2,485.9	3,046.5	2,314.1	3,068.0
Growth (%)	-53.0	148.7	6.9	-18.7	22.6	-24.0	32.6
Other Spending	9,133.7	15,515.1	18,072.9	19,125.8	20,128.0	17,607.2	18,581.9
Growth (%)	-31.8	69.9	16.5	5.8	5.2	-12.5	5.5

Source: Gartner (June 2011)

As semiconductor growth continues, worldwide wafer fab equipment (WFE) revenue is expected to grow 11.7 per cent in 2011. Intel, foundry and NAND spending will drive the need for leading-edge equipment, thus benefiting immersion lithography, etch, and certain segments in deposition involved in double patterning and critical leading-edge logic processes.

Worldwide packaging and assembly equipment (PAE) revenue is expected to experience the smallest growth in 2011 at 3.6 per cent. Back-end manufacturers realised sizable growth in 2010, but the market began to slow in the fourth quarter of last year. Orders have softened some as supply comes in line with demand. For back-end process providers' capital expenditures (capex), 3D packaging and copper wire bonding for lower-cost solutions are currently a major focus. Most major tool segments will see growth in 2011, but advanced tooling should outperform the general market this year.

In 2011, the worldwide automated test equipment (ATE) market is expected to grow about 6.9 per cent. Gartner's 2011 growth expectations are driven by the continued demand from system on a chip (SoC) and the advanced radio frequency (RF) segments of the market. Memory ATE will likely pull back in 2011 as DRAM capex softens. However, NAND testing platforms should remain strong this year.

This research is produced by Gartner's Semiconductor Manufacturing program. This research program, which is part of the overall semiconductor research group, provides a comprehensive view of the entire semiconductor industry, from manufacturing to device and application market trends. More information on Gartner's semiconductor research can be found in the Gartner Semiconductor Manufacturing Focus Area at http://www.gartner.com/it/products/research/asset_129175_2395.jsp.

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